2013 Flexible & Printed Electronics Conference & Exhibition Proceedings

Description: The 2013 Flex Conference Proceedings is a compendium of presentations from the foremost experts in flexible and printed electronics, as they shared their technical and business insights on the rapid developments in the field. Presentations which include excellent overviews of the markets that are, or will be, impacted by these foundational materials, processes and equipment, are highlighted in the first 16 presentations. The next 70+ presentations hold additional technical details on these technologies. The proceedings unfold to present a great overview of how printed and “smart” electronics are being used to create systems with more interactivity, providing such applications as smart packaging and smart sensor systems for health monitoring of people and structures.

Contents:

Quick Links:

DAY ONE - WEDNESDAY, JANUARY 30, 2013

Session 1: Corporate Innovation and Materials
1.1 Innovation Beyond the Core - Dr. Dave Edwards, Avery Dennison (Ex CTO, Retired)
1.2 Organic Photovoltaic and Organic Sensor Materials at EMD Chemicals – Making the Future Flexible™ - Dr. Monica Davis, EMD Chemicals
1.3 Polyester Film Substrates for the Flexible Electronics Industry - An Overview and Where Next - Dr. Bill MacDonald, DuPont Teijin Films

Session 2: The OLED Journey
2.1 The Advantages and Challenges of OLED – From Launching the First OLED to Today - Teruo (Ted) Tohma, Consultant
2.2 High Quality White OLED for Lighting Application - Dr. Takuya Komoda, Panasonic Corporation
2.3 Opportunities for Flexible OLEDs - Dr. Mike Hack, Universal Display Corporation
2.4 Next Generation Lighting Industry Alliance - Keith Cook, Philips Lighting

Session 3: Cutting Edge Innovative Technology and Products
3.1 Creating the Future of Printed Electronics - Dr. Janos Veres, PARC
3.2 Market Opportunities for Printed Integrated Systems - Dr. Davor Sutija, Thin Film Electronics ASA
3.3 Reshaping Electronics for the Human Body - Dr. Kevin Dowling, MC10
3.4 Flexible Choices - David Barnes, BizWitz LLC

Session 4: The Future – Printing, Nano and Industrialization
4.1 Printable Spacecraft: NASA Applications for Flexible Electronics - Kendra Short, Jet Propulsion Laboratory
4.2 NanoBio Manufacturing of Flex Devices for Aerospace - Dr. Jeff Stuart, Lockheed Martin & Dr. Richard Vaia, Air Force Research Laboratory
4.3 Inkjet Based Roll to Roll Nanoimprint Process and Applications - Dr. S. V. Sreenivasan, University of Texas at Austin and Molecular Imprints, Inc
4.4 Building a Global Network for the Printed Electronics Industry - Andy Hannah, Plextronics and OE-A
4.5 Transforming a Science Project into Industrial Reality - Indro Mukerjee, Plastic Logic

DAY TWO - THURSDAY, JANUARY 31, 2013

Session 5: Printing 1
5.1 The Realities of High Speed R2R Printing - Dr. Chip Tonkin, Clemson University
5.2 Conductive Carbon Nanotube Films for High-Speed Printing Applications - Dr. Christopher Landorf, Brewer Science, Inc.
5.3 Printed Intelligence from Rolls to Flexible and 3D Systems and Products - Dr. Harri Kopola, VTT Technical Research Centre of Finland
5.4 Printing for Profits: Making Money in Printed Electronics from Materials and Investments - Dr. Anthony Vicari, Lux Research
5.5 Screen Printing of an Etchant for Patterning Sputtered ITO Films on PET - Dr. Dania Alsaid, Western Michigan University

Session 6: OPV & Lighting
6.1 OLED, OPV and Other Applications: Materials and Processing Choices Between Vacuum S2S and Solution R2R - Dr. Jan Blochwitz-Nimoth, NOVALED AG
6.2 Air-Stable Electrodes for Organic Photovoltaics: Toward Completely Plastic Solar Cells and Modules - Dr. Bernard Kippelen, Georgia Institute of Technology
6.3 Flexible Solar Cells - Dr. Vishal Shrotriya, Solarmer Energy, Inc
6.4 Production Methods for Large Area Flexible Electronics and OPV - Thomas Kolbusch, Coatema Coating Machinery GmbH
6.5 Large-Area OLED with Silver Nanowire Anode - Dr. Florian Pschenitzka, Cambrios Technologies
6.6 Stretchable Transparent Electrodes and Stretchable Polymer OLEDs - Dr. Lu Li, University of California, Los Angeles

Session 7: Novel Display Technology
7.1 OTFT Technology and Color Displays - Dr. Peter Fischer, Plastic Logic
7.2 Technology and Product Advances in Flexible Electrophoretic Displays - Dr. Michael McCreary, E Ink
7.3 Beyond e-Reading: Industrial Applications for Electronic Paper - Hidetoshi (Heeday) Danjo, Toppan Printing
7.4 Bistable e-Wetting Frontplane for Flexible Displays - Dr. Juergen Rawert, Liquids in Motion GmbH
7.5 Opalux's P-Ink Technology: Low-power, Flexible, Color-Tunable Surfaces - Dr. Andre Arsenault, Opalux Inc
7.6 The Future of the Flexible Display Market and Technology - Sweta Dash, IHS
7.7 Functional Film for Flexible Display: R2R Coating Process - Dr. Nizamidin Jappar, Kimoto Tech, Inc

Session 8: Circuit & System Applications
8.1 Flexible Materials and Devices for Advanced Power - Ray Chan, MicroLink Devices, Inc & Dr. Michael Durstock, Air Force Research Lab
8.2 Technical Developments in Commercializing Printed Memory and Integrated Systems - Dr. Christer Karlsson, Thin Film Electronics ASA
8.3 From Lab-scale Ink-jet to Mass-produced Printed Circuits - Dr. Gregory Whiting, PARC
8.4 Printed Organic CMOS and Sensors for Large Area Systems on Flexible Foils - Dr. Romain Gwoziecki, CEA-LITEN
8.5 FleX™ Silicon-on-Polymer™: Flexible (Pliable) ICs from Commercial Foundry Processes - Doug Hackler, American Semiconductor, Inc
8.6 Flexible Hybrid Systems in Conformal Load-Bearing Antenna Structures - Richard Chaney, American Semiconductor, Inc

Session 9: Medical Sensors
9.1 Bringing Wearable Electronics to the Masses - John (Ivo) Stivoric, BodyMedia
9.2 Use of Printed Electronics in Flexible Devices - Dr. Ana Arias, University of California, Berkeley
9.3 Fabrication Of Wearable Sensors For Human Health Monitoring Through Magnetically Directed Assembly Techniques - Jeffrey Ashe, General Electric Global Research
9.4 Medical Smart Patch - Dr. John Bell, Physical Optics Corporation
9.5 Conductive Textile Ribbons to Replace Traditional Wires and Smart Clothing Electrodes - Michael Corbett, WEEL Technologies

Session 10: Printing 2
10.1 Improving the Accuracy of Flexo Printing for Flexible Electronics - Dr. Tim Claypole, WCPC, Swansea University
10.2 Recent Advances in Lower Cost Conductors for Printed Electronics Applications - Dr. Jay Dorfman, DuPont Electronics and Communications
10.3 Advancements Made in Materials Deposition Inkjet Systems and Printheads - Tim Luong, FUJIFILM Dimatix, Inc
10.4 Systems for Printing Conductive Traces for General Electronic and Electrical Products - Dr. Robert Detig, Electrox

Session 11: Barriers
11.1 Large Area Flexible OLEDs: Solution Processing and R2R Technologies - Dr. George Götz, Holst Centre
11.2 Scaling up ALD Moisture Barrier Technology - Brad Aitchison, Beneq Oy
11.3 Novel Dispensable Getters: Scavenging Technologies Making Printed Electronics Possible - Dr. Stefano Tominetti, SAES Getters
11.4 Flexible Transparent Ultrabarrier Films for Flexible Electronics - Dr. Ravi Prasad, Vitriflex

Session 12: Materials
12.1 Organic and Oxide Materials for Unconventional Opto-Electronics - Dr. Antonio Facchetti, Polyera Corporation
12.2 Morphology Development in Semiconducting Polymer Inks During Solvent Evaporation: Watching the Ink Dry - Dr. Christopher Soles, NIST
12.3 Orthogonal Processing: A New Strategy for Organic Electronics - Dr. Christopher Ober, Cornell University
12.4 Clear Hard Coat Films via Hybrid Multi-layer (HML) Vacuum Deposition - Dr. Jim DiBattista, Darly Custom Technology
12.5 Shocking Technologies’ Embedded ESD Solution for Flexible Printed Circuits - Dr. Robert Fleming, Shocking Technologies
12.6 Copper Nano-Particle Based Screen-Paste Formulations and Use in Consumer Electronic Applications - Dr. Michael Carmody, Intrinsiq Materials

DAY THREE - FRIDAY, FEBRUARY 1, 2013

Session 13: Sensors
13.1 Design of Printed Transistor Circuits for Printed Sensors - Dr. David Schwartz, PARC
13.2 Temperature and Moisture Sensors Printed on Flexible Plastic Substrates Using CNT-Based Nanomaterials - Dr. Lyong (Alex) Diao, Brewer Science
13.3 Touch 2.0 - Full Surface Pressure Touch and Imaging Sensors - Gerry Siedman, Tactonic Technologies
13.4 An Ultra-Thin flexible Monolithic CMOS Imaging Test Structure for Applications in Bendable Image Sensors - Georgios Dogiamis, University Duisburg Essen - Fraunhofer Institute IMS
13.5 Novel Flexible Sensors with Thin Film Assembly of Functional Nanoparticles - Dr. Chuan-Jian Zhong, Binghamton University

Session 14: Oxide TFTs
14.1 Amorphous Oxide Materials and Device Technology for FPDs - Dr. Apostolos (Tolis) Voutsas, Sharp Labs of America
14.2 TFT on Flexible Substrates - Dr. Yoon-Hoon Kim, Korea Electronics Technology Institute
14.3 II-VI Materials and Devices for Flexible Transparent Electronics – Dr. Israel Mejia, University of Texas at Dallas
14.4 Roll-to-Roll Plasma Enhanced Chemical Vapor Deposition for Next Generation Thin Film Electronic Device & Ultra High Barrier Applications - Tobias Stolley, Applied Materials
14.5 Flexible Electronics – What is it Good For? – Dr. David Allee, Arizona State University

Session 15: Transparent Conductors
15.1 Transparent Conductor Films for Large-Area Touch Based on Silver Nanowires - Dr. Florian Pschenitzka, Cambrios Technologies
15.2 Extremely High Throughput Nanofabrication: Patterned Deposition and Inline Sintering of Silver Nanoparticles - Dr. Bruce Kahn, Clemson University
15.3 Conductive Polymer Films and Invisible Patterning Techniques for Transparent Electrode Applications - Dr. Ron Lubianez, Heraeus Precious Metals North America Conshohocken LLC
15.4 Preparation of Invisible Metal-Grid Transparent Electrodes by Electrohydrodynamic Printing and Its Application to Optoelectronic Devices - Dr. Jihoon Kim, Kongju National University, Korea
15.5 Towards Commercial Viability of Flexible Transparent Conductive Films: New Single Walled Carbon Nanotubes Ink - Dr. Sian Fogden, Linde Nanomaterials
15.6 Market Forecasts for Conductive Inks and Transparent Conductive Films - Dr. Harry Zervos, IDTechEx

Session 16: OTFT & Novel Devices
16.1 Flexible Energy Harvesting and Storage Systems - Dr. Keon Jae Lee, Korea Advanced Institute of Science and Technology
16.2 Realization of Double Digit Efficiency Polymer Solar Cells - Dr. Gang Li, University of California, Los Angeles
16.3 Fabricating Novel OTFTs Using a Hybrid Electrodeposition Technique - John Rudin, Hewlett Packard Laboratories
16.4 Fully Printed CNT Based TFT Electronics - Dr. Kosmas Galatsis, SWeNT and University of California, Los
An Active Matrix Microphone - Dr. Ioannis Kymissis, Columbia University

Session 17: Flexible Glass
17.1 Flexible Glass Substrates for Thin, Light, and Conformal Electronic Devices - Dr. Sean Garner, Corning Inc
17.2 High-Temperature, Roll-to-Roll Process on Flexible Glass – Dr. Sean Garner & Dr. Lili Tian, Corning Inc
17.3 Microsystems Enabled PV - Dr. Murat Okandan, Sandia National Laboratories
17.4 Lightweight Electrowetting Displays on Thin Flexible Glass Substrates - Dr. Andrew Steckl, University of Cincinnati
17.5 Growth of Aluminum-Doped Zinc Oxide on Flexible Glass Substrates and Cyclic Bending Reliability Study - Chien-Yi Peng, Center for Autonomous Solar Power (CASP)

Session 18: Manufacturing Processes
18.1 Convergence of Printing Technology, Self-Assembly and Nanoimprint Lithography for R2R Fabrication of Functional Electronic Materials and Devices - Dr. Jim Watkins, University of Massachusetts
18.2 Design and Process Management For Novel Manufacturing Processes - Dr. Tolga Kurtoglu, PARC
18.3 New Atmospheric Plasma Technologies for Flexible Electronics - Rory Wolf, Enercon Industries Corporation
18.4 Advances in Roll-to-Roll Process Manufacturing and Challenges to be Aware of - Mark Wegner, Northfield Automation Systems, Inc
18.5 Laser Lift-Off Processes for Flexible Displays - Dr. Qiongying Hu, Coherent, Inc
18.6 RFID as Application for Photonic Curing and Copper Reduction Ink - Stan Farnsworth, NovaCentrix
18.7 Stexs™ - Short Thermal Exposure Sources for Carrier-Gas Enhanced Vapor Phase Deposition. Addressing Mass Manufacturing Requirements for Organic Material Thinfilm Deposition with Advanced Evaporation Sources. - Juergen Kreis, Aixtron

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